

D

TOP VIEW

SIDE VIEW

BOTTOM VIEW

е

<u></u> 7х L

Ф



PIN ONE REFERENCE

0.10 С

0.10 C

С 0.05

С 0.05

e/2

 \triangle

UDFN8, 1.6x1, 0.4P CASE 517BY **ISSUE O**

C SEATING PLANE

0.10 M C A B

0.05 M C NOTE 3

Ε

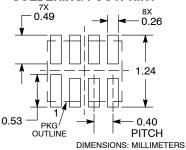
DATE 18 MAY 2011

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION b APPLIES TO PLATED
 TERMINAL AND IS MEASURED BETWEEN
- 0.15 AND 0.20 MM FROM TERMINAL TIP.
 4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.45	0.55	
A1	0.00	0.05	
А3	0.13 REF		
b	0.15	0.25	
D	1.60 BSC		
Е	1.00 BSC		
е	0.40 BSC		
L	0.25	0.35	
L1	0.30	0.40	

RECOMMENDED **SOLDERING FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



X = Specific Device Code M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	UDFN8, 1.6X1, 0.4P		PAGE 1 OF 1

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